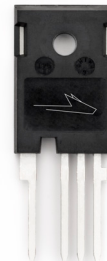


# C3M0015065K

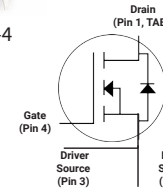
Silicon Carbide Power MOSFET  
C3M™ MOSFET Technology  
N-Channel Enhancement Mode

## Features

- C3M™ SiC MOSFET technology
- Optimized package with separate driver source pin
- 8 mm of creepage distance between drain and source
- High blocking voltage with low on-resistance
- High-speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery ( $Q_{rr}$ )
- Halogen free, RoHS compliant



TO-247-4



Package Types: TO-247-4  
PN's: C3M0015065K

Wolfspeed, Inc. is in the process of rebranding its products and related materials pursuant to the entity name change from Cree, Inc. to Wolfspeed, Inc. During this transition period, products received may be marked with either the Cree name and/or logo or the Wolfspeed name and/or logo.

## Typical Applications

- EV chargers
- Solar inverters
- UPS
- SMPS
- DC/DC converters

## Benefits

- Reduce switching losses and minimize gate ringing
- Higher system efficiency
- Reduce cooling requirements
- Increase power density
- Increase system switching frequency

## Key Parameters

Parameter	Symbol	Min.	Typ.	Max	Unit	Conditions	Note
Drain - Source Voltage	$V_{DS}$			650	V	$T_c = 25^\circ\text{C}$	
Maximum Gate - Source Voltage	$V_{GS(max)}$	-8		+19		Transient	
Operational Gate-Source Voltage	$V_{GS op}$		-4/15			Static	Note 1
DC Continuous Drain Current	$I_D$			120	A	$V_{GS} = 15\text{ V}, T_c = 25^\circ\text{C}, T_J \leq 175^\circ\text{C}$	Fig. 19
				96		$V_{GS} = 15\text{ V}, T_c = 100^\circ\text{C}, T_J \leq 175^\circ\text{C}$	Note 2
Pulsed Drain Current	$I_{DM}$			418		$t_{pmax}$ limited by $T_{Jmax}$ $V_{GS} = 15\text{ V}, T_c = 25^\circ\text{C}$	Fig. 22
Power Dissipation	$P_D$			416	W	$T_c = 25^\circ\text{C}, T_J = 175^\circ\text{C}$	Fig. 20
Operating Junction and Storage Temperature	$T_J, T_{stg}$			-40 to +175	$^\circ\text{C}$		
Solder Temperature	$T_L$			260		According to JEDEC J-STD-020	
Mounting Torque	$M_D$			1 8.8	Nm lbf-in	M3 or 6-32 screw	

Note (1): Recommended turn-on gate voltage is 15V with  $\pm 5\%$  regulation tolerance, see Application Note PRD-04814 for additional details

Note (2): Verified by design


**Electrical Characteristics** ( $T_c = 25^\circ\text{C}$  Unless Otherwise Specified)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions	Note
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	650				$V_{GS} = 0\text{ V}, I_D = 100\text{ }\mu\text{A}$	
Gate Threshold Voltage	$V_{GS(th)}$	1.8	2.3	3.6	V	$V_{DS} = V_{GS}, I_D = 15.5\text{ mA}$	Fig. 11
			1.9			$V_{DS} = V_{GS}, I_D = 15.5\text{ mA}, T_J = 175^\circ\text{C}$	
Zero Gate Voltage Drain Current	$I_{DSS}$		1	50	$\mu\text{A}$	$V_{DS} = 650\text{ V}, V_{GS} = 0\text{ V}$	
Gate-Source Leakage Current	$I_{GSS}$		10	250	nA	$V_{GS} = 15\text{ V}, V_{DS} = 0\text{ V}$	
Drain-Source On-State Resistance	$R_{DS(on)}$		15	21	m $\Omega$	$V_{GS} = 15\text{ V}, I_D = 55.8\text{ A}$	Fig. 4, 5, 6
			20			$V_{GS} = 15\text{ V}, I_D = 55.8\text{ A}, T_J = 175^\circ\text{C}$	
Transconductance	$g_{fs}$		42		S	$V_{DS} = 20\text{ V}, I_{DS} = 55.8\text{ A}$	Fig. 7
			40			$V_{DS} = 20\text{ V}, I_{DS} = 55.8\text{ A}, T_J = 175^\circ\text{C}$	
Input Capacitance	$C_{iss}$		5011		pF	$V_{GS} = 0\text{ V}, V_{DS} = 400\text{ V}$ $f = 100\text{ kHz}$ $V_{AC} = 25\text{ mV}$	Fig. 17, 18
Output Capacitance	$C_{oss}$		289				
Reverse Transfer Capacitance	$C_{rss}$		31				Note: 3
Effective Output Capacitance (Energy Related)	$C_{o(er)}$		357				
Effective Output Capacitance (Time Related)	$C_{o(tr)}$		516				
$C_{oss}$ Stored Energy	$E_{oss}$		29		$\mu\text{J}$		Fig. 16
Turn-On Switching Energy (Body Diode)	$E_{ON}$		252		$\mu\text{J}$	$V_{DS} = 400\text{ V}, V_{GS} = -4\text{ V}/15\text{ V}, I_D = 55.8\text{ A},$ $R_{G(ext)} = 2.5\text{ }\Omega, L = 36\text{ }\mu\text{H}, T_J = 175^\circ\text{C}$ FWD = Internal Body Diode of MOSFET	Fig. 25
Turn-Off Switching Energy (Body Diode)	$E_{OFF}$		180				
Turn-On Switching Energy (External Diode)	$E_{ON}$		189		$\mu\text{J}$	$V_{DS} = 400\text{ V}, V_{GS} = -4\text{ V}/15\text{ V}, I_D = 55.8\text{ A},$ $R_{G(ext)} = 2.5\text{ }\Omega, L = 36\text{ }\mu\text{H}, T_J = 175^\circ\text{C}$ FWD = External SiC Diode	Fig. 25
Turn-Off Switching Energy (External Diode)	$E_{OFF}$		192				
Turn-On Delay Time	$t_{d(on)}$		16		ns	$V_{DD} = 400\text{ V}, V_{GS} = -4\text{ V}/15\text{ V}$ $I_D = 55.8\text{ A}, R_{G(ext)} = 2.5\text{ }\Omega,$ Timing Relative to $V_{DS}$ Inductive Load	Fig. 26
Rise Time	$t_r$		24				
Turn-Off Delay Time	$t_{d(off)}$		43				
Fall Time	$t_f$		12				
Internal Gate Resistance	$R_{G(int)}$		1.5		$\Omega$	$f = 1\text{ MHz}, V_{AC} = 25\text{ mV}$	
Gate to Source Charge	$Q_{gs}$		49		nC	$V_{DS} = 400\text{ V}, V_{GS} = -4\text{ V}/15\text{ V}$ $I_D = 55.8\text{ A}$ Per IEC60747-8-4 pg 21	Fig. 12
Gate to Drain Charge	$Q_{gd}$		55				
Total Gate Charge	$Q_g$		188				

Note (3):  $C_{o(er)}$ , a lumped capacitance that gives same stored energy as  $c_{oss}$  while  $V_{DS}$  is rising from 0 to 400 V.

$C_{o(tr)}$ , a lumped capacitance that gives same charging time as  $c_{oss}$  while  $V_{DS}$  is rising from 0 to 400 V.

Reverse Diode Characteristics (T<sub>c</sub> = 25 °C Unless Otherwise Specified)

Parameter	Symbol	Typ.	Max.	Unit	Test Conditions	Note
Diode Forward Voltage	V <sub>SD</sub>	4.7		V	V <sub>GS</sub> = -4 V, I <sub>SD</sub> = 27.9 A, T <sub>J</sub> = 25 °C	Fig. 8, 9, 10
		4.2			V <sub>GS</sub> = -4 V, I <sub>SD</sub> = 27.9 A, T <sub>J</sub> = 175 °C	
Continuous Diode Forward Current	I <sub>S</sub>		79	A	V <sub>GS</sub> = -4 V, T <sub>C</sub> = 25 °C	
Diode Pulse Current	I <sub>SM</sub>		223		V <sub>GS</sub> = -4 V, Pulse Width t <sub>p</sub> Limited by T <sub>Jmax</sub>	
Reverse Recovery Time	t <sub>rr</sub>	19		ns	V <sub>GS</sub> = -4 V, I <sub>SD</sub> = 55.8 A, V <sub>R</sub> = 400 V dif/dt = 6080 A/μs, T <sub>J</sub> = 175 °C	
Reverse Recovery Charge	Q <sub>rr</sub>	510		nC		
Peak Reverse Recovery Current	I <sub>rrm</sub>	60		A		
Reverse Recovery Time	t <sub>rr</sub>	24		ns	V <sub>GS</sub> = -4 V, I <sub>SD</sub> = 55.8 A, V <sub>R</sub> = 400 V dif/dt = 1850 A/μs, T <sub>J</sub> = 175 °C	
Reverse Recovery Charge	Q <sub>rr</sub>	432		nC		
Peak Reverse Recovery Current	I <sub>rrm</sub>	30		A		

Thermal Characteristics

Parameter	Symbol	Typ.	Unit	Test Conditions	Note
Thermal Resistance from Junction to Case	R <sub>θJC</sub>	0.35	°C/W		Fig. 21
Thermal Resistance from Junction to Ambient	R <sub>θJA</sub>	40			

Typical Performance

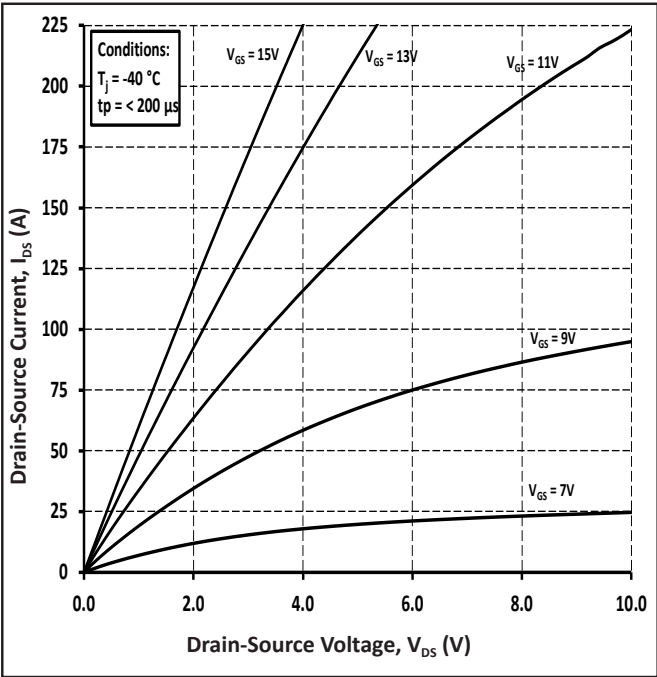


Figure 1. Output Characteristics  $T_j = -40\text{ }^{\circ}\text{C}$

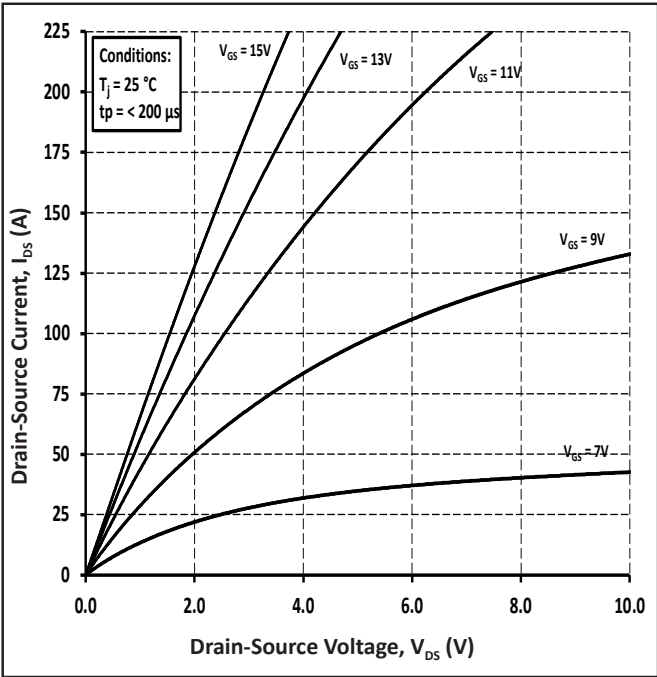


Figure 2. Output Characteristics  $T_j = 25\text{ }^{\circ}\text{C}$

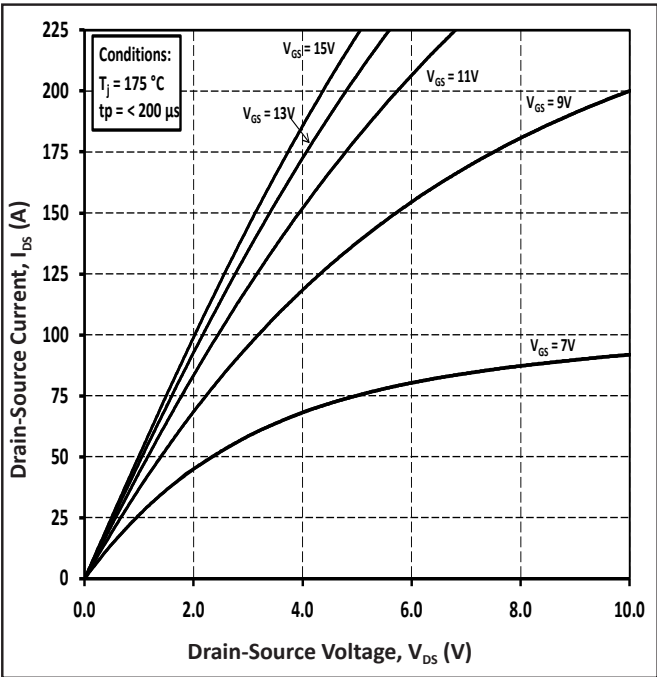


Figure 3. Output Characteristics  $T_j = 175\text{ }^{\circ}\text{C}$

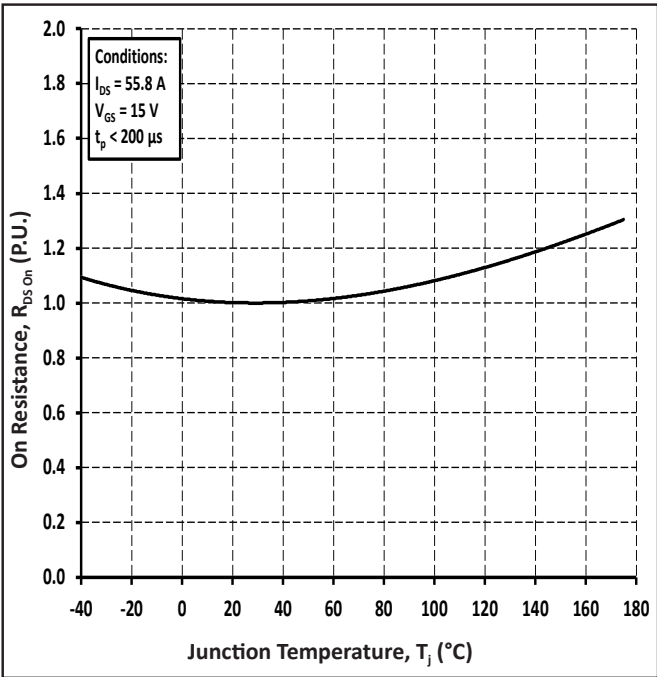


Figure 4. Normalized On-Resistance vs Temperature

Typical Performance

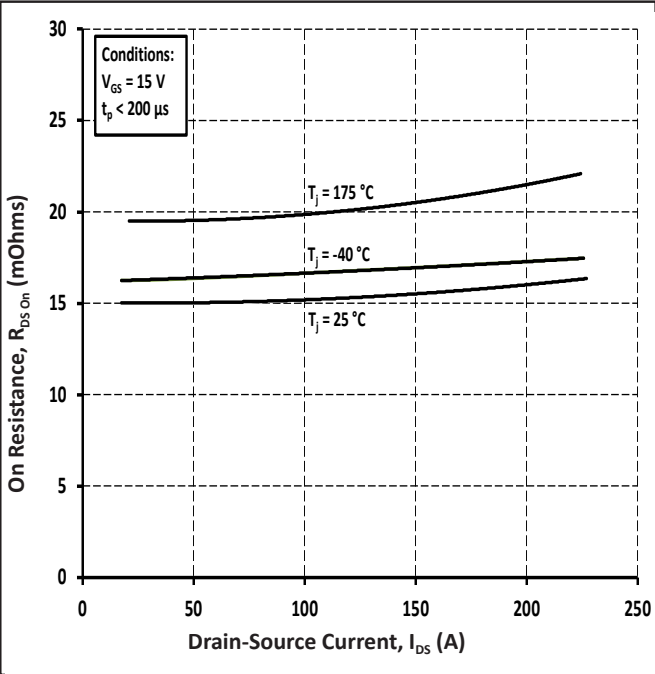


Figure 5. On-Resistance vs Drain Current for Various Temperatures

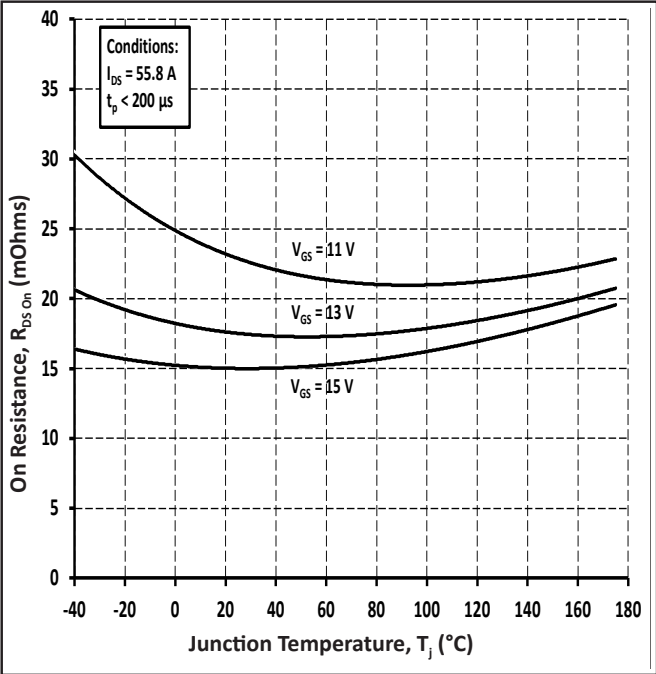


Figure 6. On-Resistance vs Temperature for Various Gate Voltage

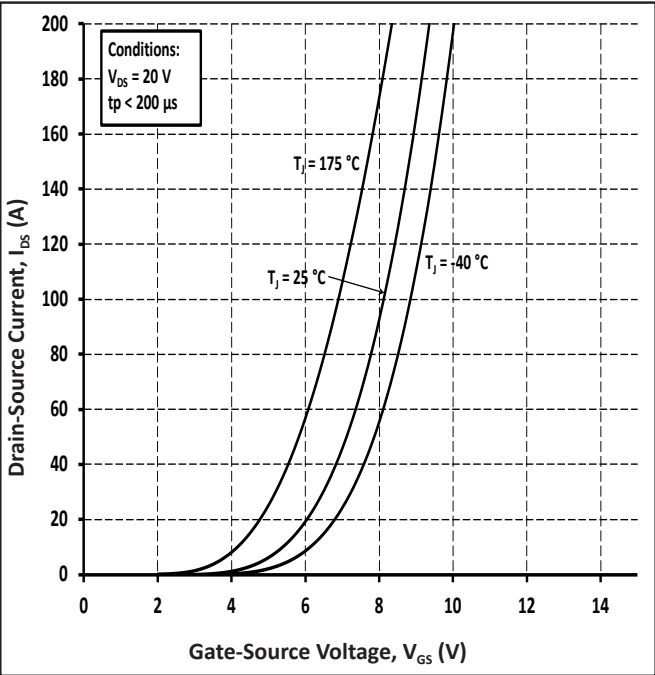


Figure 7. Transfer Characteristic for Various Junction Temperatures

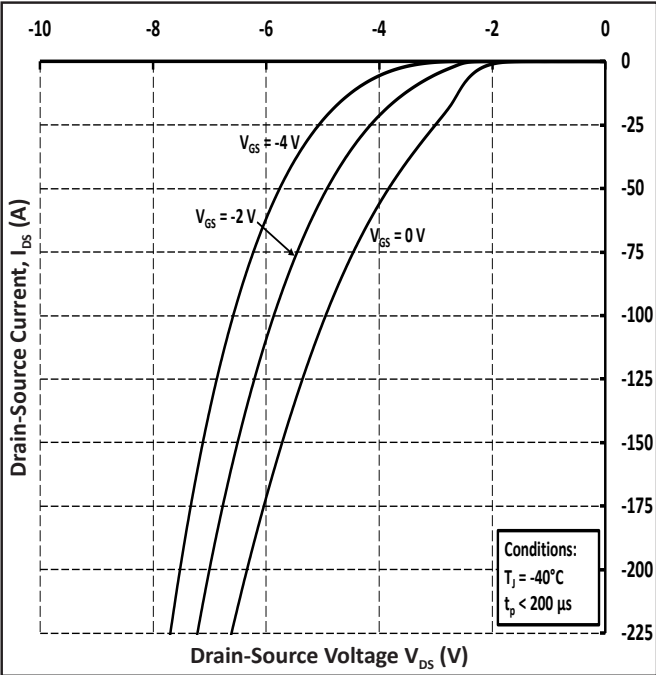


Figure 8. Body Diode Characteristic at -40 °C



Typical Performance

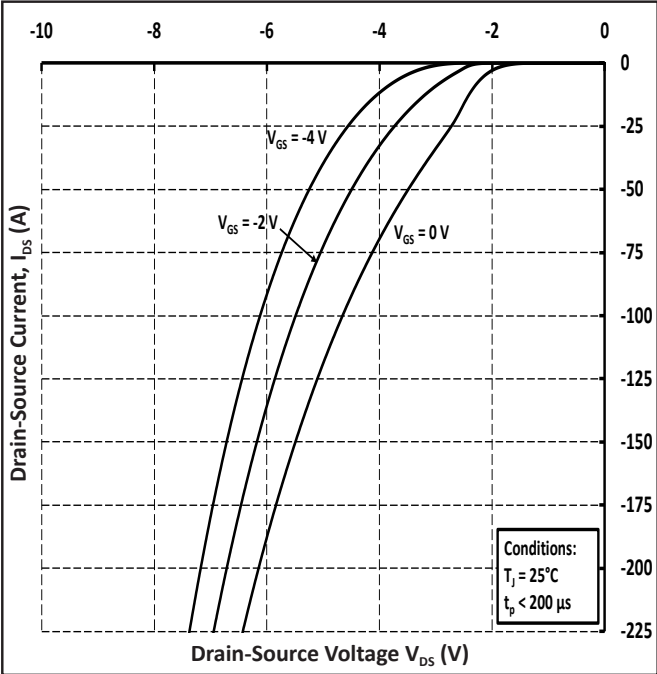


Figure 9. Body Diode Characteristic at 25 °C

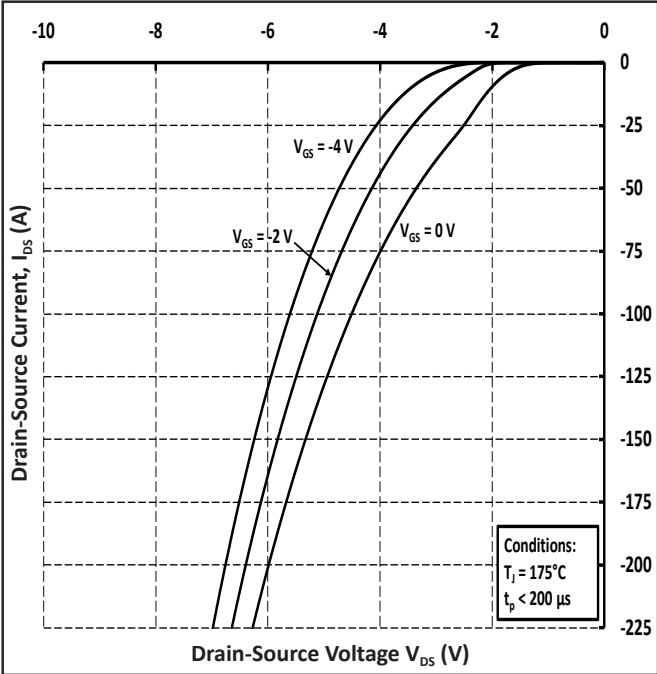


Figure 10. Body Diode Characteristic at 175 °C

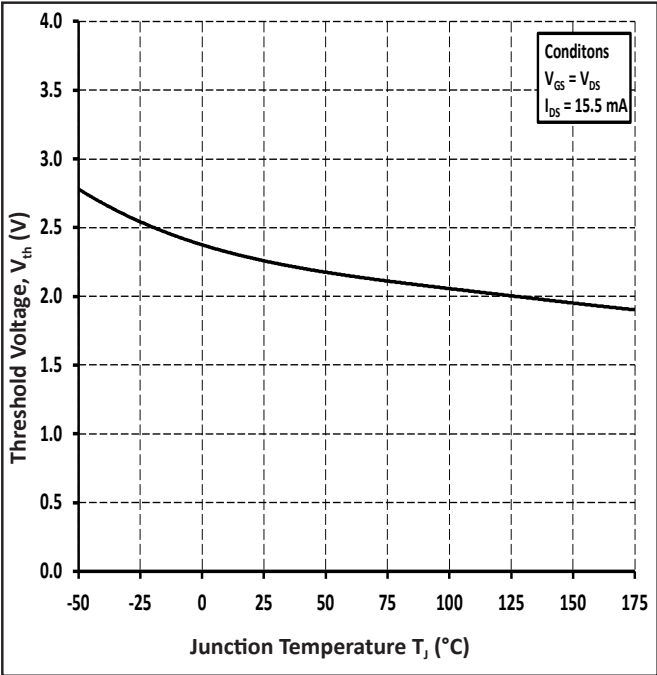


Figure 11. Threshold Voltage vs Temperature

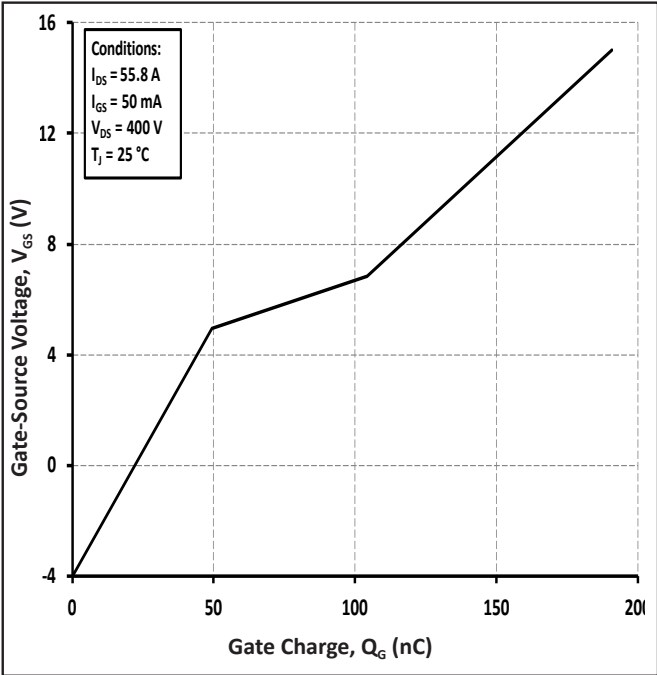


Figure 12. Gate Charge Characteristic



Typical Performance

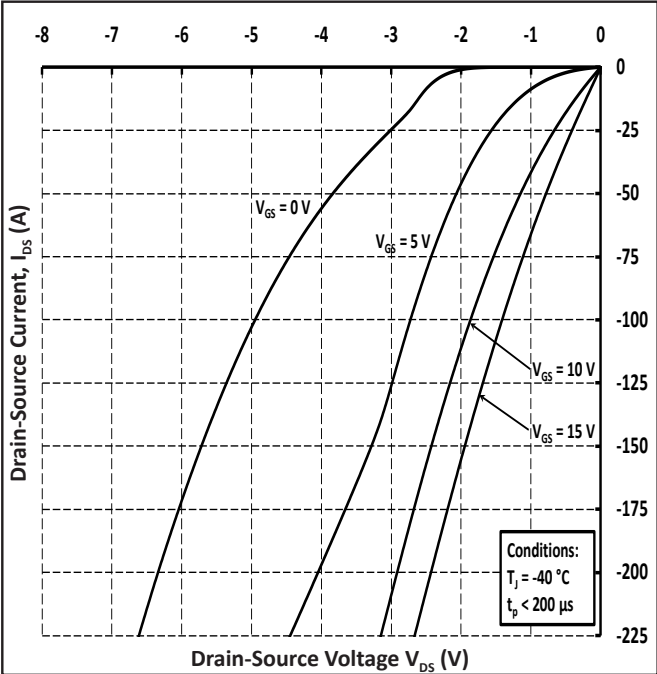


Figure 13. 3<sup>rd</sup> Quadrant Characteristic at  $-40\text{ }^{\circ}\text{C}$

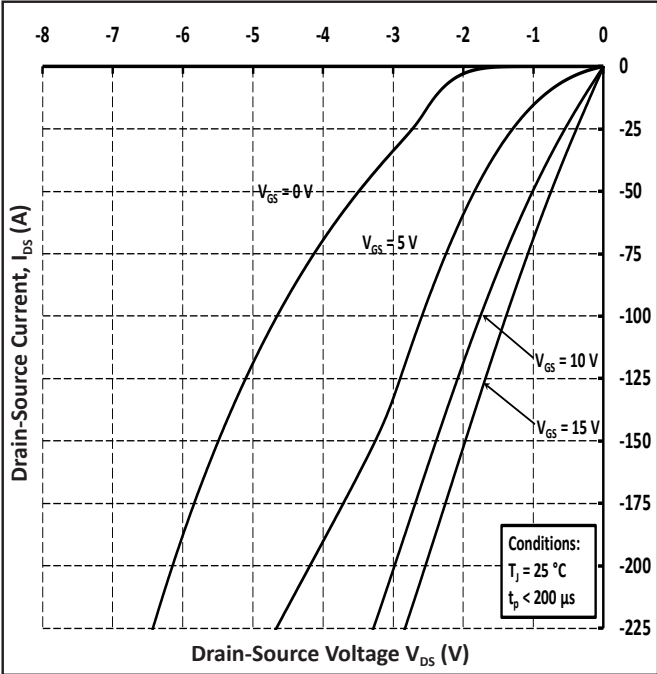


Figure 14. 3<sup>rd</sup> Quadrant Characteristic at  $25\text{ }^{\circ}\text{C}$

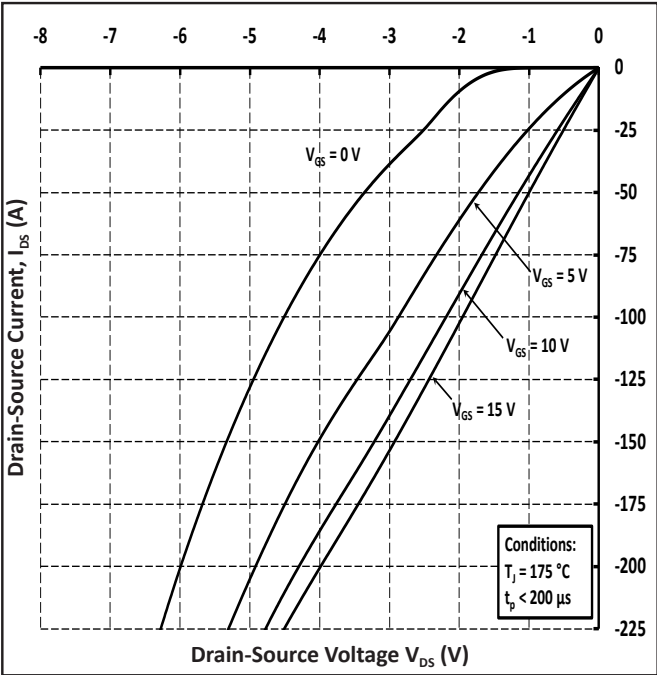


Figure 15. 3<sup>rd</sup> Quadrant Characteristic at  $175\text{ }^{\circ}\text{C}$

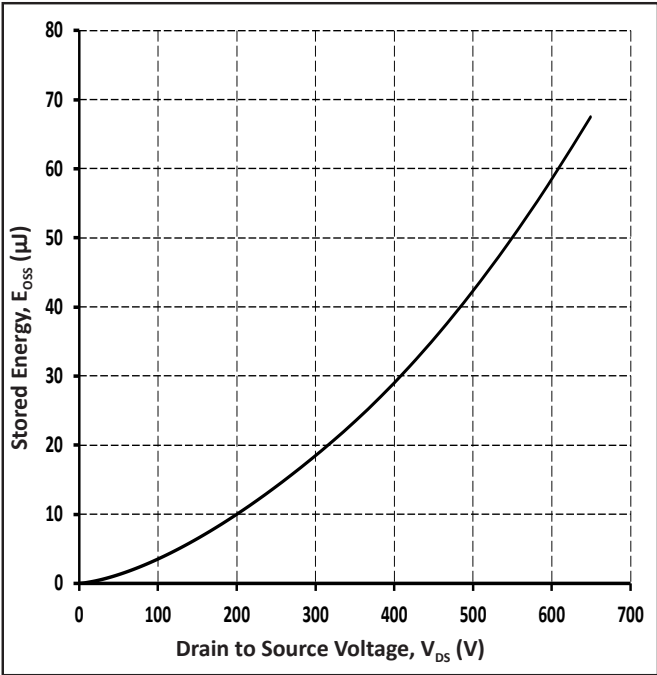


Figure 16. Output Capacitor Stored Energy



## Typical Performance

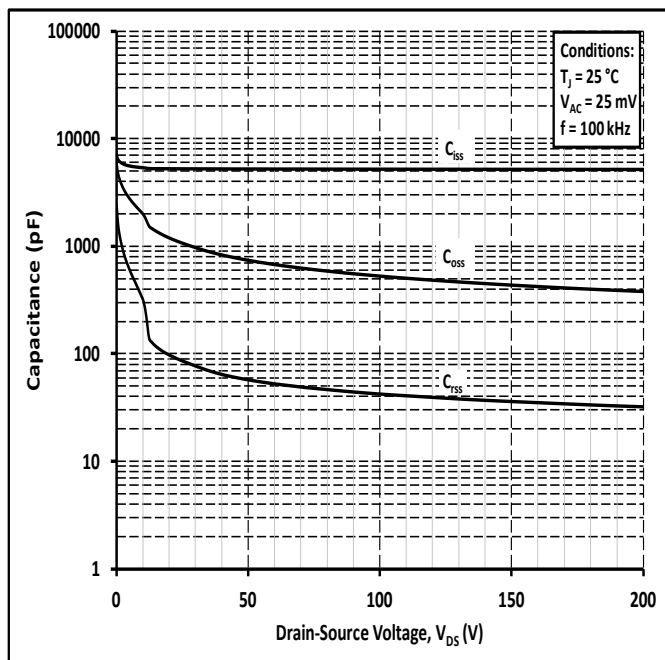


Figure 17. Capacitances vs Drain-Source Voltage (0-200 V)

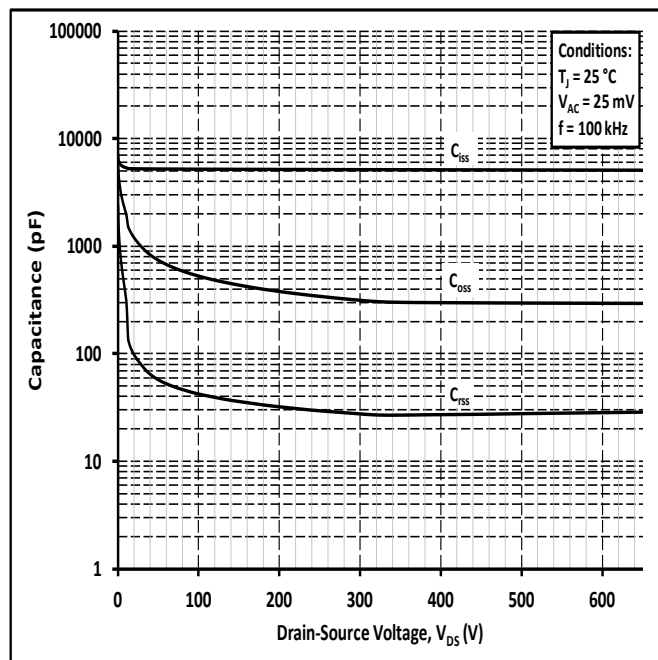


Figure 18. Capacitances vs Drain-Source Voltage (0-650 V)

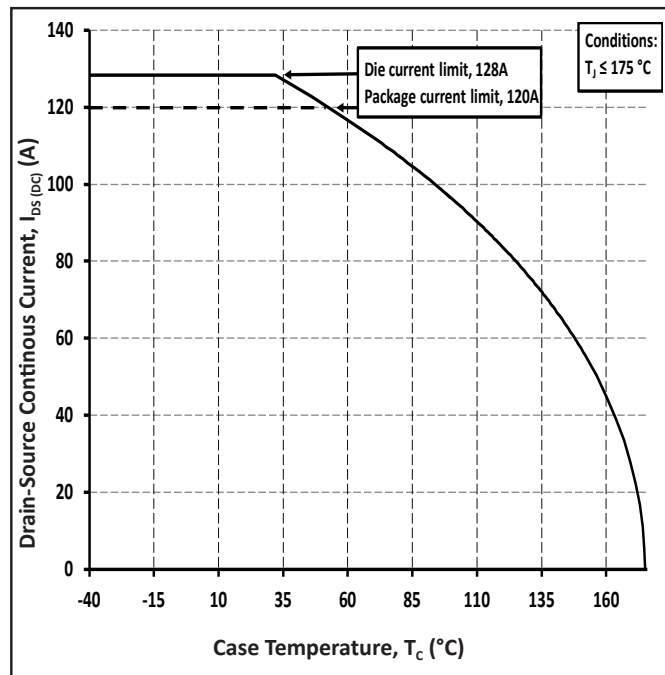


Figure 19. Continuous Drain Current Derating vs Case Temperature

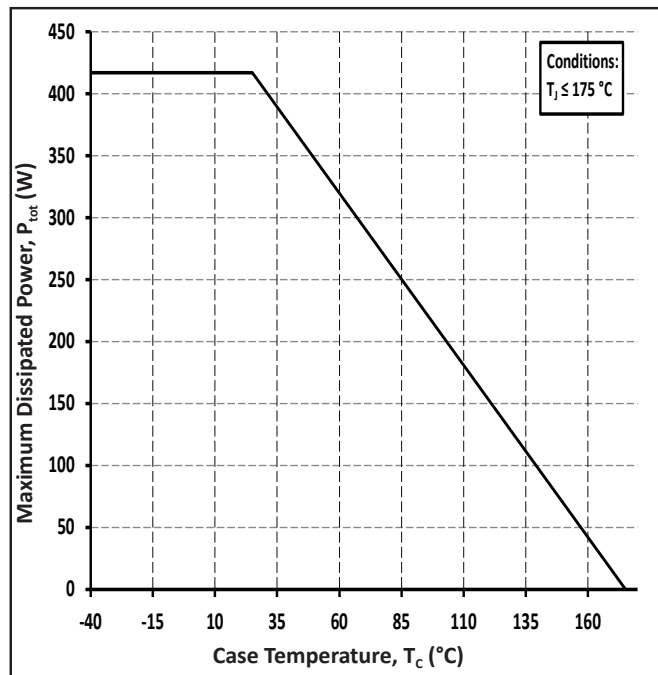


Figure 20. Maximum Power Dissipation Derating vs Case Temperature





## Typical Performance

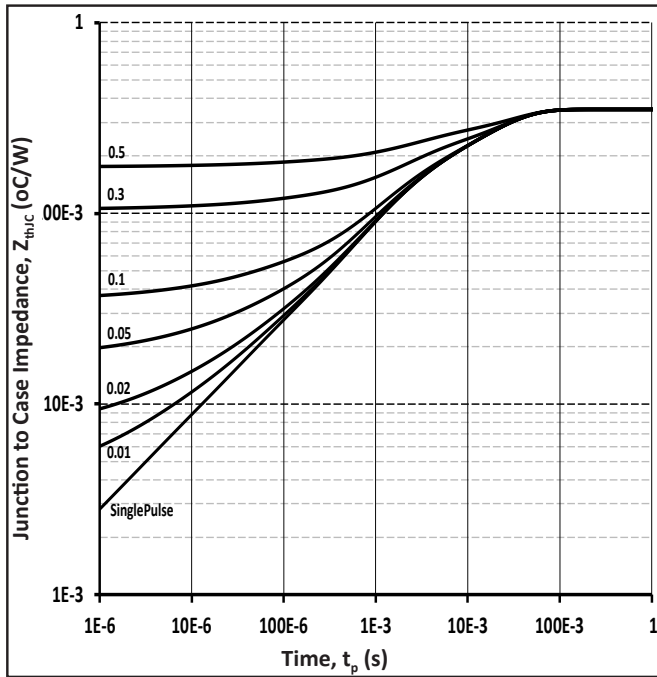


Figure 21. Transient Thermal Impedance (Junction - Case)

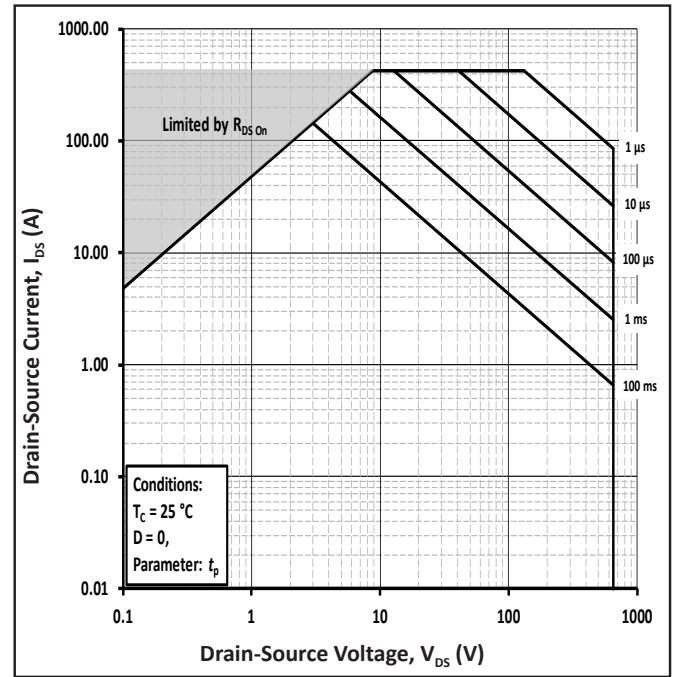


Figure 22. Safe Operating Area

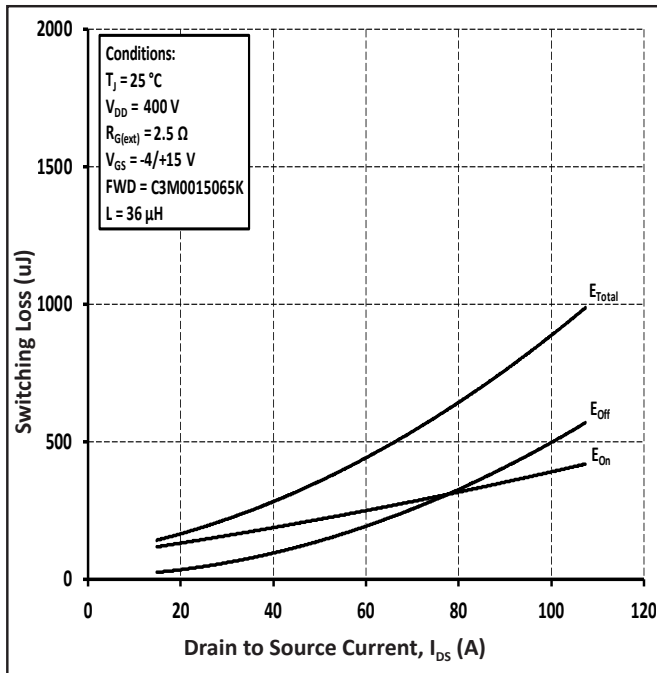


Figure 23. Clamped Inductive Switching Energy vs Drain Current ( $V_{DD} = 400\text{ V}$ )

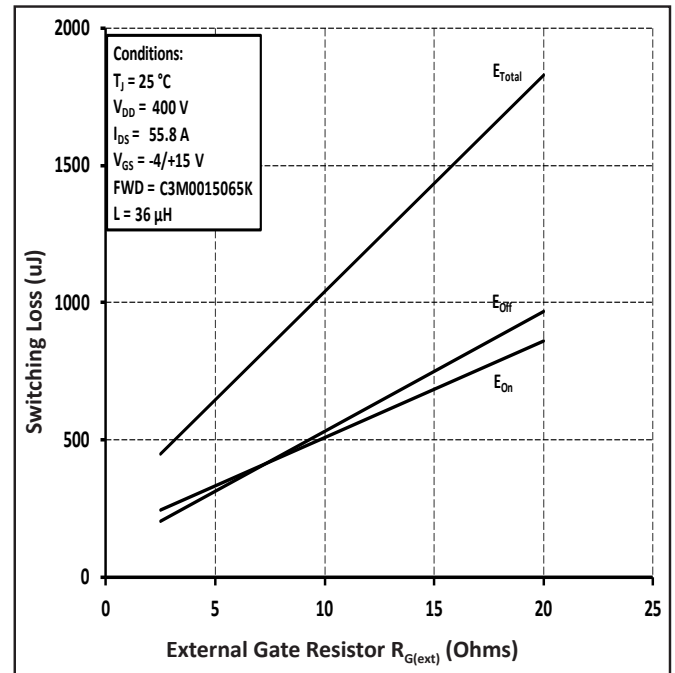


Figure 24. Clamped Inductive Switching Energy vs  $R_{G(ext)}$



Typical Performance

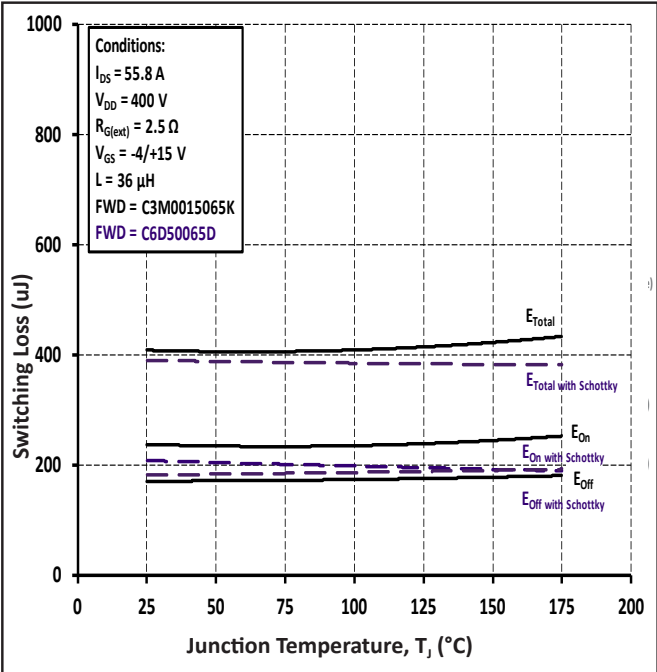


Figure 25. Clamped Inductive Switching Energy vs Temperature

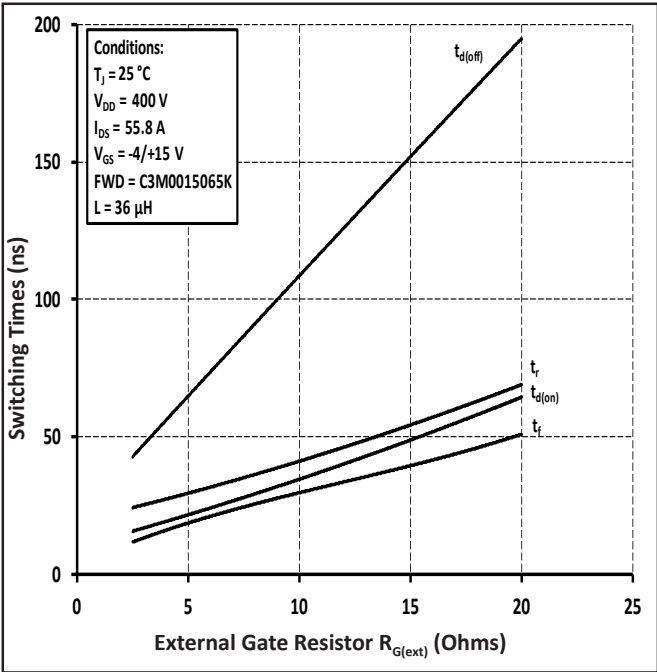


Figure 26. Switching Times vs  $R_{G(ext)}$

## Test Circuit Schematic

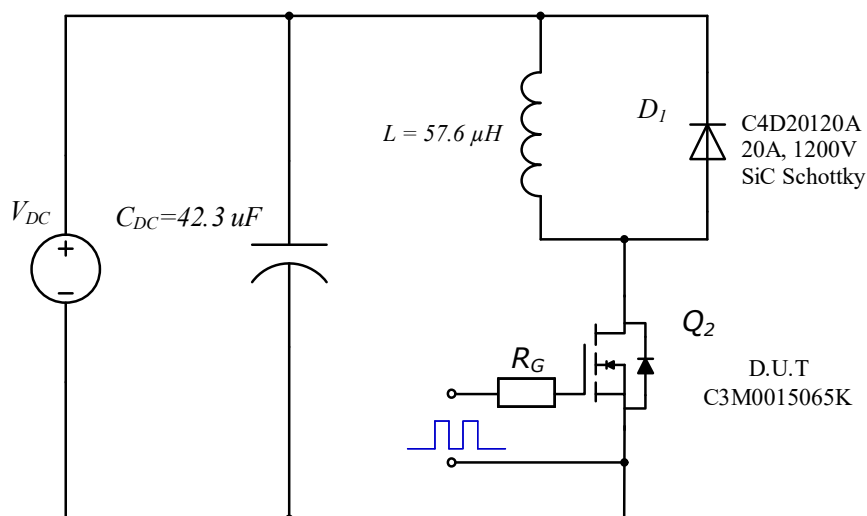


Figure 27. Clamped Inductive Switching Waveform Test Circuit

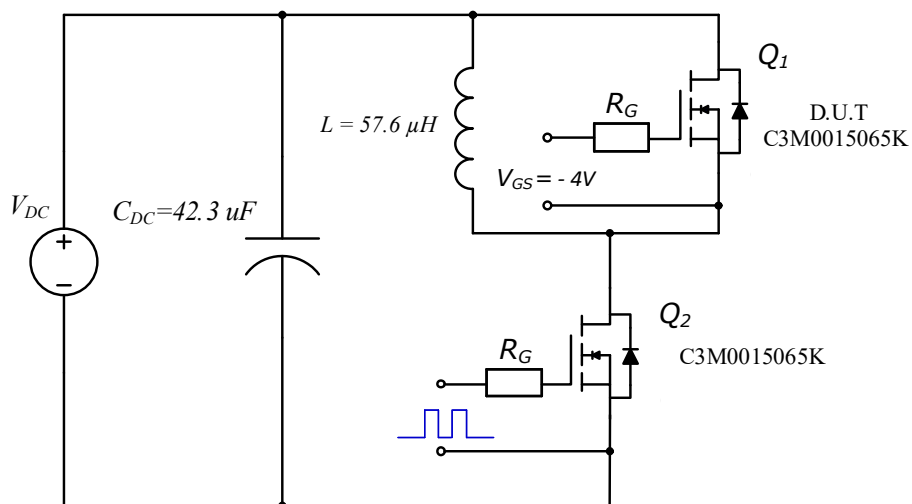
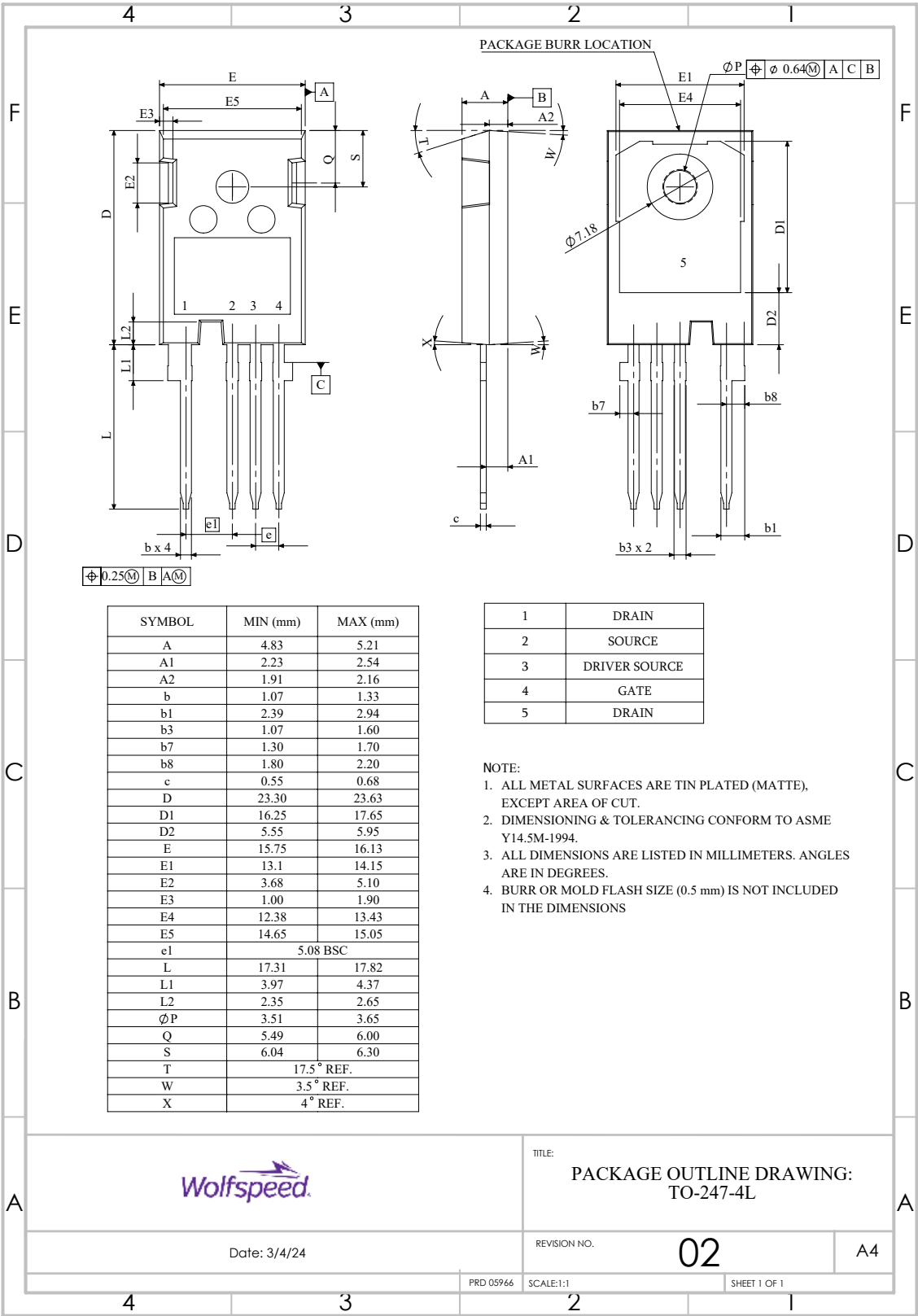


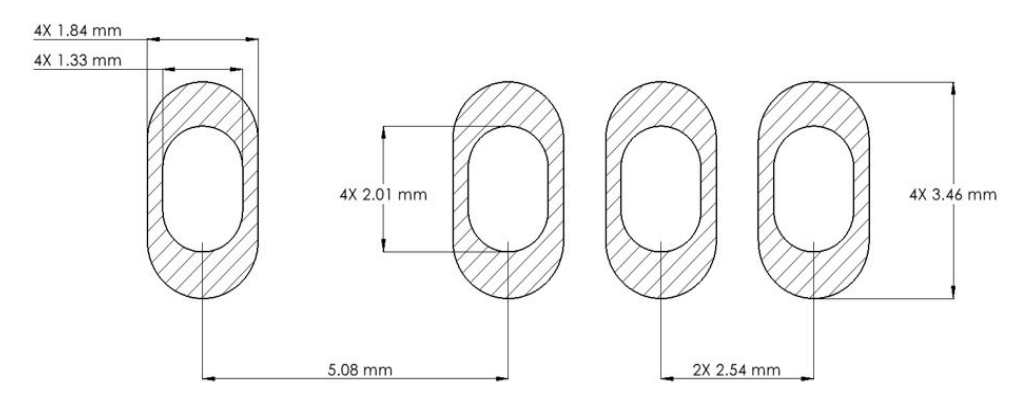
Figure 28. Body Diode Recovery Test Circuit

Package Dimensions

Package: TO-247-4L



Recommended Solder Pad Layout



Part Number	Package	Marking
C3M0015065K	TO-247-4L	C3M0015065K



Revision History

Current Revision	Date of Release	Description of Changes
6	September-2023	N/A
7	December-2023	Updated Wolfspeed branding, package drawing, and solder pad layout, package image, added revision history, Table 1 layout revised
8	April-2024	RDSON LSL Removed, Dynamic Data updated for 2.5 $\Omega$ and Fig 12, 23, 24, 25, and 26 updated accordingly
9	September - 2025	Legal Disclaimer, POD, Diode Pulse Current Symbol



## Notes & Disclaimer

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